

Application No. 10/609,249  
Response to Office Action

Customer No. 01933

**Listing of Claims:**

1. (Currently Amended) A head supporting arrangement  
comprising:

a base plate;

a support spring; and

5 at least one microactuator device connected between said  
base plate and said support spring, said microactuator device  
having a cut face formed by cutting,

wherein said cut face is subjected to an anti-release  
treatment for preventing release of particles produced by the  
10 cutting, and

wherein said microactuator device and portions of said  
base plate and said support spring adjacent to said  
microactuator device are coated with a coating film so that  
said microactuator device is entirely enclosed by said coating  
15 film.

2. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 1, wherein said  
anti-release treatment is carried out by baking an entire  
surface of said microactuator device including said cut face  
to form a sintered ~~image~~ surface after cutting the  
microactuator device into a final product shape.

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3. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said anti-release treatment is carried out by polishing an entire surface of said microactuator device including said cut face formed by cutting after baking the microactuator device.

4. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said anti-release treatment is carried out by reheating an entire surface of said microactuator device including said cut face  
5 formed by cutting after baking the microactuator device to thereby refix said particles to said entire surface.

5. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said anti-release treatment is carried out by exclusively heating said cut face formed by cutting after baking the microactuator device to thereby refix said particles to said cut face.

6. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 2, wherein said anti-release treatment is followed by a washing of an the entire surface of said microactuator device including said cut face to remove said particles.

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7. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 3, wherein said anti-release treatment is followed by a washing of ~~an~~ the entire surface of said microactuator device including said cut face to remove said particles.

8. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 4, wherein said anti-release treatment is followed by a washing of ~~an~~ the entire surface of said microactuator device including said cut face to remove said particles.

9. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 5, wherein said anti-release treatment is followed by a washing of an entire surface of said microactuator device including said cut face to remove said particles.

10. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said anti-release treatment is carried out by coating said cut face formed by cutting after baking the microactuator device with a glass to avoid exposure of said cut face.

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11. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said anti-release treatment is carried out by coating an entire surface of said microactuator device including said cut face  
5 formed by cutting after baking ~~the microactuator device~~ with a flexible resin material ~~which hardly suppresses the~~ such that a displacement of said microactuator device is substantially unaffected.

12. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 1, wherein said microactuator device comprises a multilayer structure which includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~ includes said cut face.

13. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 2, wherein said microactuator device comprises a multilayer structure which includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~ includes said cut face.

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14. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 3, wherein said microactuator device comprises a multilayer structure which includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~ includes said cut face.

15. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 4, wherein said microactuator device comprises a multilayer structure which includes a plurality of piezoelectric elements and a plurality of internal electrodes alternately laminated and which ~~has~~ includes said cut face.

16. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 5, wherein said microactuator device comprises a multilayer structure which includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~ includes said cut face.

17. (Currently Amended) ~~A microactuator device~~ The head supporting arrangement according to claim 7, wherein said microactuator device comprises a multilayer structure which

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includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~  
includes said cut face.

18. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 8, wherein said  
microactuator device comprises a multilayer structure which  
includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which ~~has~~  
includes said cut face.

19. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 6, wherein said  
microactuator device comprises a multilayer structure which  
includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which  
includes said cut face.

20. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 7 10, wherein said  
microactuator device comprises a multilayer structure which  
includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which  
includes said cut face.

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21. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 8 11, wherein said  
microactuator device comprises a multilayer structure which  
includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which  
includes said cut face.

22. (Currently Amended) ~~A microactuator device~~ The head  
supporting arrangement according to claim 9, wherein said  
microactuator device comprises a multilayer structure which  
includes a plurality of piezoelectric elements and a plurality  
5 of internal electrodes alternately laminated and which  
includes said cut face.